

08-11-2000

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SHEET

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office



101429720

To the Honorable Commissioner of Patents and Trademarks: Please receive the attached original document or copy thereof.

1. Name(s) of conveying party(ies):

- 1) OW CHEE MOON
- 2) ENG MEOW KOON
- 3)
- 4)
- 5)
- 6)

*Handwritten:* LRD  
6-28-00

Additional names of conveying parties attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ Other

Execution Dates:

- 1) JUNE 21, 2000 4)
- 2) JUNE 21, 2000 5)
- 3) 6)

2. Name and address of receiving party:

Name: MICRON TECHNOLOGY, INC.

Internal Address:

Street Address: 8000 SOUTH FEDERAL WAY

City BOISE State ID

Zip: 83706-9632

Additional names & addresses attached? ☐ Yes ☒ No

PTO  
09/606432

06/28/00

4. Application number(s) or registration number(s):

If this document is being filed together with a new application,  
the execution date of the application is JUNE 28, 2000

A. Patent Application No(s).

B. Patent No(s).

*Handwritten:* 09/606432

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: PERKINS COIE LLP

Internal Address: PATENT-SEA

PAUL T. PARKER

Street Address: P.O. Box 1247

City: SEATTLE State: WA ZIP: 98111-1247

6. Total number of applications and patents involved.....

1

7. Total Fee (37 CFR 3.41): 40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit account number: 50-0665

08/10/2000 DNGUYEN 00000167 500665 09606432

01 FC-581 40.00 CH

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

PAUL T. PARKER

Name of Person Signing

Signature

Date

*Handwritten:* 6/28/2000

Total number of pages including cover sheet, attachments, and document:

4

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ow Chee Moon  
Eng Meow KoonDocket No.: 108298507US  
Disclosure Number: 99-0961

Filed: Concurrently Herewith

For: STACKED-DIE ASSEMBLIES  
WITH A PLURALITY OF  
MICROELECTRONIC DEVICES)  
AND METHODS OF  
MANUFACTURE

## A S S I G N M E N T :

☒ Enclosed for recording  
☐ Previously recordedDate: \_\_\_\_\_  
Reel: \_\_\_\_\_

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and is entitled "STACKED-DIE ASSEMBLIES WITH A PLURALITY OF MICROELECTRONIC DEVICES AND METHODS OF MANUFACTURE"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and


specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.



Date: 21 JUN 2000

Ow Chee Moon

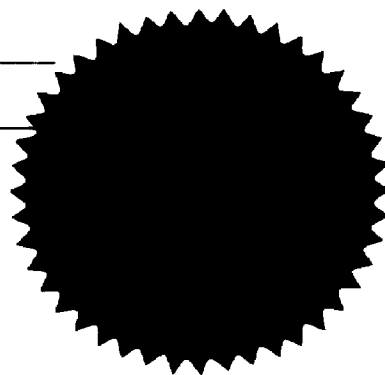
I certify that I know or have satisfactory evidence that Ow Chee Moon is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it to be his free and voluntary act for the uses and purposes mentioned in the instrument.

21 JUN 2000

Dated \_\_\_\_\_

Signature of  
Witness \_\_\_\_\_

Printed Name \_\_\_\_\_



Eng Meow Koon  
Eng Meow Koon

Date: 21 JUN 2000

I certify that I know or have satisfactory evidence that Eng Meow Koon is the person who appeared before me, and said person acknowledged that he signed this instrument and acknowledged it to be his free and voluntary act for the uses and purposes mentioned in the instrument.

Dated 21 JUN 2000

Signature of  
Witness

Printed Name

